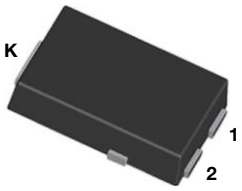
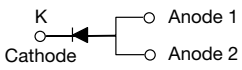
Low Noise High Current Density Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier

Ultra Low V_F = 0.4 V at I_F = 6 A

eSMP® Series



SMPC (TO-277A)



FEATURES

- Very low profile - typical height of 1.1 mm
- Trench MOS Schottky technology
- Low forward voltage drop, low power losses
- High efficiency operation
- Low reverse spike voltage
- Very low junction capacitance
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
  - Automotive ordering code; base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

AUTOMOTIVE GRADE Available

RoHS COMPLIANT

HALOGEN FREE

LINKS TO ADDITIONAL RESOURCES

3D Models | Packages | Marking

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	12 A
V_{RRM}	60 V
I_{FSM}	240 A
V_F at I_F = 12 A (T_J = 125 °C)	0.49 V
T_J max.	175 °C
Package	SMPC (TO-277A)
Circuit configuration	Single

TYPICAL APPLICATIONS

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

MECHANICAL DATA

Case: SMPC (TO-277A)
Molding compound meets UL 94 V-0 flammability rating
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade
Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102
M3 and HM3 suffix meets JESD 201 class 2 whisker test

MAXIMUM RATINGS (T_A = 25 °C unless otherwise noted)			
PARAMETER	**SYMBOL**	**V12PM64**	**UNIT**
Device marking code		12M64	
Maximum repetitive peak reverse voltage	V_{RRM}	60	V
Maximum average forward rectified current (fig. 1)	I_F (1)	12	A
	I_F (2)	4.8	
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I_{FSM}	240	A
Operating junction temperature range	T_J (3)	-40 to +175	°C
Storage temperature range	T_{STG}	-55 to +175	°C

Notes

(1) Mounted on 30 mm x 30 mm pad areas aluminum PCB
(2) Free air, mounted on recommended copper pad area
(3) The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

ELECTRICAL CHARACTERISTICS (T_J = 25 °C unless otherwise noted)						
PARAMETER	**TEST CONDITIONS**		**SYMBOL**	**TYP.**	**MAX.**	**UNIT**
Instantaneous forward voltage	I_F = 6 A	T_J = 25 °C	V_F (1)	0.50	-	V
	I_F = 12 A			0.56	0.64	
	I_F = 6 A	T_J = 125 °C		0.40	-	
	I_F = 12 A			0.49	0.57	
Reverse current	V_R = 60 V	T_J = 25 °C	I_R (2)	-	0.015	mA
		T_J = 125 °C		1.6	5	
Typical junction capacitance	4.0 V, 1 MHz		C_J	490	-	pF

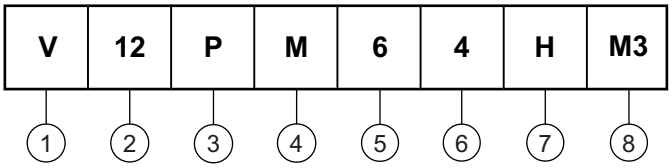
Notes
(1) Pulse test: 300 µs pulse width, 1 % duty cycle
(2) Pulse test: pulse width ≤ 5 ms

THERMAL CHARACTERISTICS (T_A = 25 °C unless otherwise noted)			
PARAMETER	**SYMBOL**	**V12PM64**	**UNIT**
Typical thermal resistance	$R_{\theta JA}$ (1)(2)	75	°C/W
	$R_{\theta JM}$ (3)	4	

Notes
(1) The heat generated must be less than the thermal conductivity from junction to ambient: $dP_D/dT_J < 1/R_{\theta JA}$
(2) Free air mounted on recommended copper pad area; thermal resistance $R_{\theta JA}$ - junction to ambient
(3) Mounted on 30 mm x 30 mm aluminum PCB; thermal resistance $R_{\theta JM}$ - junction to mount

ORDERING INFORMATION TABLE

Device code



1 - Vishay TMBS product
2 - Current rating (12 = 12 A)
3 - Package type (P = SMPC (TO-277A))
4 - Process type option (M = low I_R)
5 - Voltage rating (6 = 60 V)
6 - TMBS generation option (4 = gen 4)
7 - Quality grade (H = AEC-Q101 qualified, - = industry grade)
8 - Material / Environment category
(M3 = halogen-free, RoHS-compliant, and termination lead (Pb)-free)

ORDERING INFORMATION (Example)				
PREFERRED P/N	**UNIT WEIGHT (g)**	**PREFERRED PACKAGE CODE**	**BASE QUANTITY**	**DELIVERY MODE**
V12PM64-M3/H	0.10	H	1500	7" diameter plastic tape and reel
V12PM64-M3/I	0.10	I	6500	13" diameter plastic tape and reel
V12PM64HM3/H (1)	0.10	H	1500	7" diameter plastic tape and reel
V12PM64HM3/I (1)	0.10	I	6500	13" diameter plastic tape and reel

Note
(1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

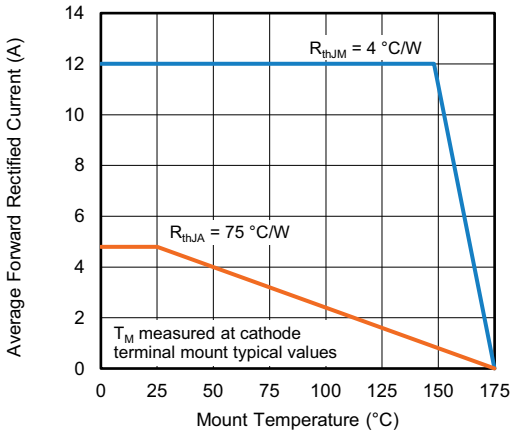


Fig. 1 - Forward Current Derating Curve

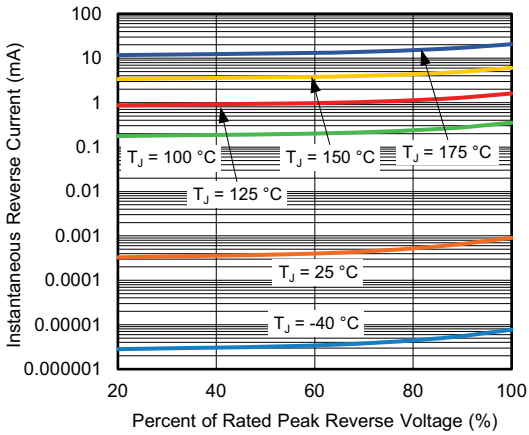


Fig. 4 - Typical Reverse Leakage Characteristics Per Diode

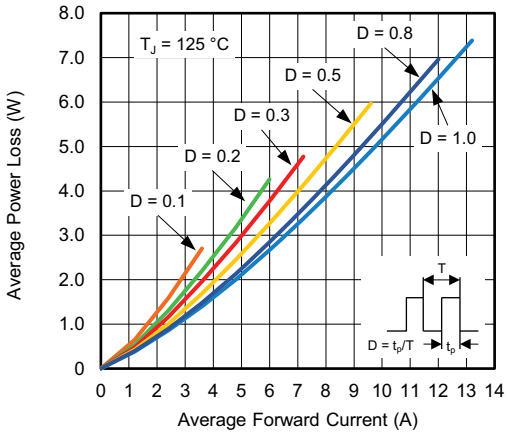


Fig. 2 - Forward Power Loss Characteristics

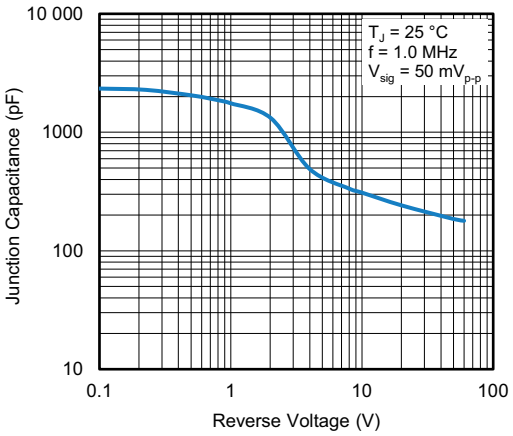


Fig. 5 - Typical Junction Capacitance

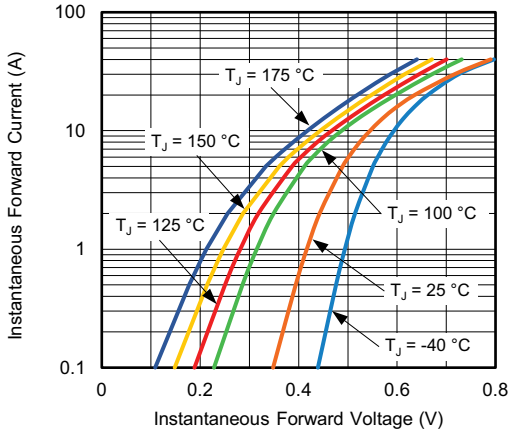


Fig. 3 - Typical Instantaneous Forward Characteristics

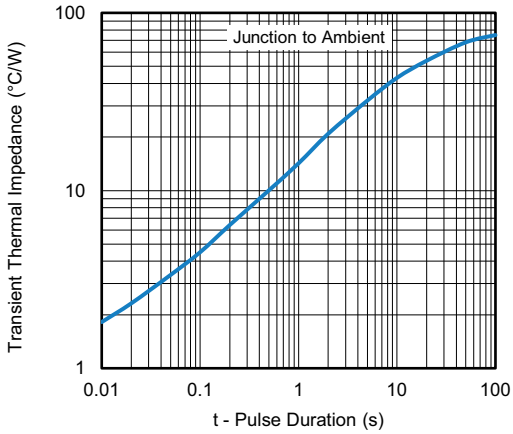
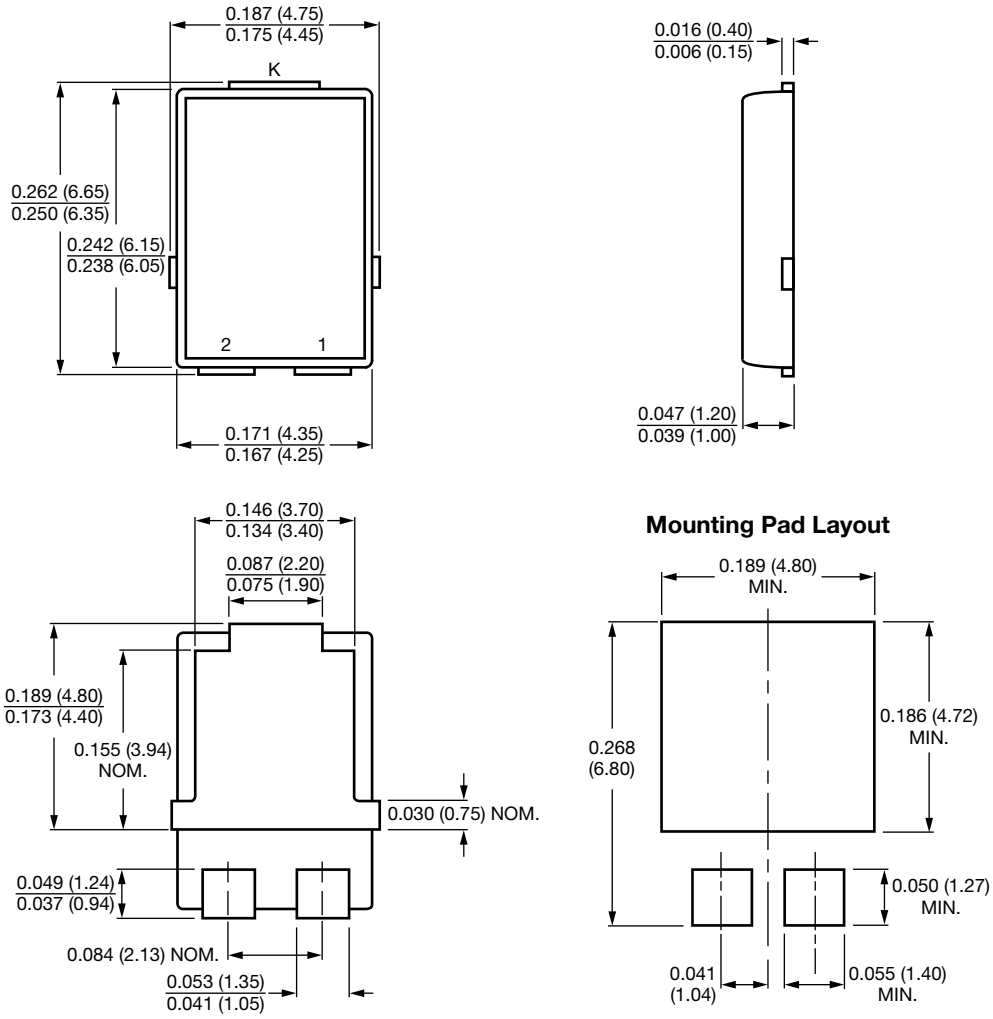


Fig. 6 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SMPC (TO-277A)



Mounting Pad Layout

Conform to JEDEC® TO-277A

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